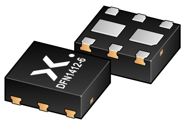


PRMB11

50 V, 100 mA PNP/PNP Resistor-Equipped double Transistors (RET)

14 September 2018 — Product data sheet

1. General description

PNP/PNP Resistor-Equipped double Transistors (RET) in an ultra small DFN1412-6 (SOT1268) leadless Surface-Mounted Device (SMD) plastic package.

NPN/NPN complement: PRMH11.

NPN/PNP complement: PRMD3.

2. Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design
- Reduces component count
- Reduces pick and place costs
- Low package height of 0.5 mm
- AEC-Q101 qualified

3. Applications

- Digital applications
- Cost-saving alternative to BC847/BC857 series in digital applications
- Control of IC inputs
- Switching loads

4. Quick reference data

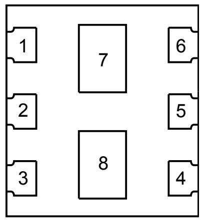
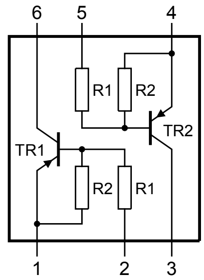
Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per transistor							
V_{CEO}	collector-emitter voltage	open base		-	-	-50	V
I_O	output current			-	-	-100	mA
h_{FE}	DC current gain	V_{CE} = -5 V; I_C = -5 mA; T_{amb} = 25 °C		30	-	-	
R1	bias resistor 1	T_{amb} = 25 °C	[1]	7	10	13	kΩ
R2/R1	bias resistor ratio		[1]	0.8	1	1.2	

[1] See section "Test information" for resistor calculation and test conditions.

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	GND1	GND (emitter) TR1	 Transparent top view DFN1412-6 (SOT1268)	 006aaa212
2	I1	input (base) TR1		
3	O2	output (collector) TR2		
4	GND2	GND (emitter) TR2		
5	I2	input (base) TR2		
6	O1	output (collector) TR1		
7	O1	output (collector) TR1		
8	O2	output (collector) TR2		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PRMB11	DFN1412-6	plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals; body: 1.4 mm x 1.2 mm x 0.47 mm	SOT1268

7. Marking

Table 4. Marking codes

Type number	Marking code
PRMB11	C5

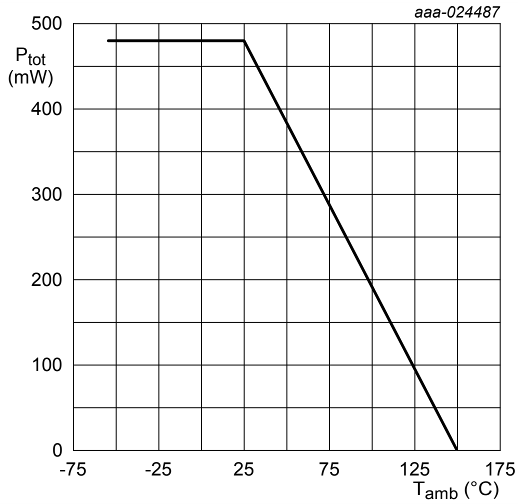
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per transistor						
V_{CBO}	collector-base voltage	open emitter		-	-50	V
V_{CEO}	collector-emitter voltage	open base		-	-50	V
V_{EBO}	emitter-base voltage	open collector		-	-10	V
V_I	input voltage	positive		-	10	V
		negative		-	-40	V
I_O	output current			-	-100	mA
P_{tot}	total power dissipation	$T_{amb} \leq 25$ °C	[1]	-	325	mW
Per device						
P_{tot}	total power dissipation	$T_{amb} \leq 25$ °C	[1]	-	480	mW
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	150	°C
T_{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



FR4 PCB, standard footprint

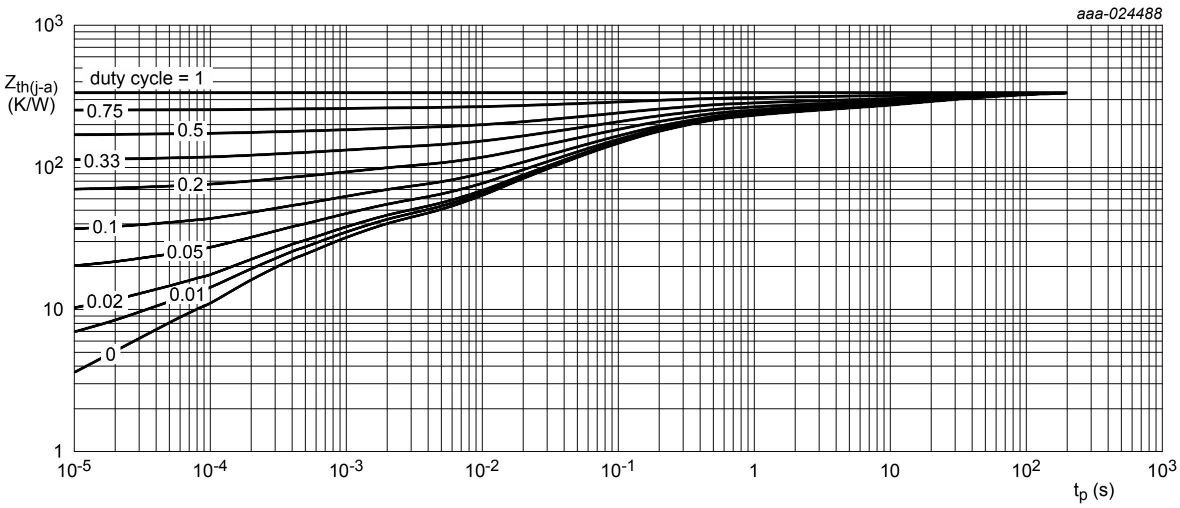
Fig. 1. Per device: Power derating curve

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per transistor							
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	385	K/W
Per device							
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	261	K/W

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



FR4 PCB, standard footprint

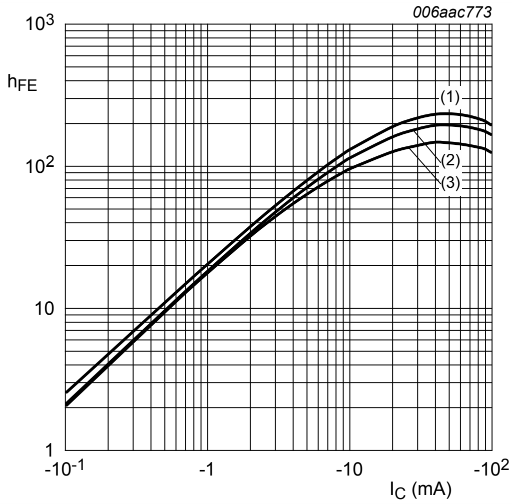
Fig. 2. Per transistor: Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

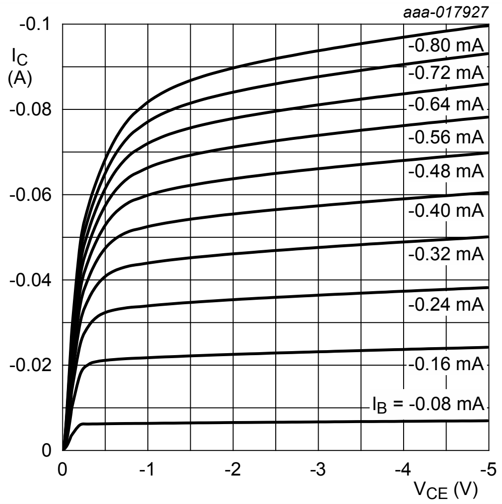
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per transistor							
I_{CEO}	collector-emitter cut-off current	V_{CE} = -30 V; I_B = 0 A; T_{amb} = 25 °C		-	-	-100	nA
		V_{CE} = -30 V; I_B = 0 A; T_j = 150 °C		-	-	-5	µA
I_{CBO}	collector-base cut-off current	V_{CB} = -50 V; I_E = 0 A; T_{amb} = 25 °C		-	-	-100	nA
I_{EBO}	emitter-base cut-off current	V_{EB} = -5 V; I_C = 0 A; T_{amb} = 25 °C		-	-	-400	µA
h_{FE}	DC current gain	V_{CE} = -5 V; I_C = -5 mA; T_{amb} = 25 °C		30	-	-	
V_{CEsat}	collector-emitter saturation voltage	I_C = -10 mA; I_B = -0.5 mA; T_{amb} = 25 °C		-	-	-150	mV
$V_{I(off)}$	off-state input voltage	V_{CE} = -5 V; I_C = -100 µA; T_{amb} = 25 °C		-	-1.1	-0.8	V
$V_{I(on)}$	on-state input voltage	V_{CE} = -0.3 V; I_C = -10 mA; T_{amb} = 25 °C		-2.5	-1.8	-	V
R1	bias resistor 1	T_{amb} = 25 °C	[1]	7	10	13	kΩ
R2/R1	bias resistor ratio		[1]	0.8	1	1.2	
C_C	collector capacitance	V_{CB} = -10 V; I_E = 0 A; i_e = 0 A; f = 1 MHz; T_{amb} = 25 °C		-	-	3	pF
f_T	transition frequency	V_{CE} = -5 V; I_C = -10 mA; f = 100 MHz; T_{amb} = 25 °C	[2]	-	180	-	MHz

[1] See section "Test information" for resistor calculation and test conditions.
[2] Characteristics of built-in transistor



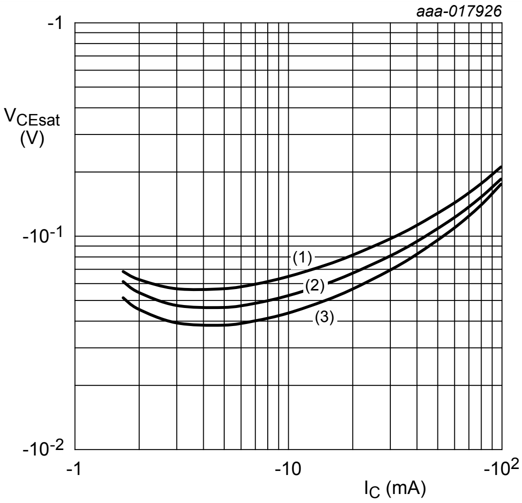
V_{CE} = -5 V
(1) T_{amb} = 100 °C
(2) T_{amb} = 25 °C
(3) T_{amb} = -40 °C

Fig. 3. DC current gain as a function of collector current; typical values



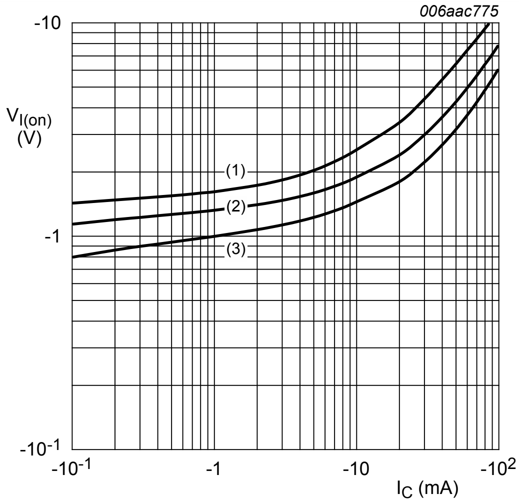
T_{amb} = 25 °C

Fig. 4. Collector current as a function of collector-emitter voltage; typical values



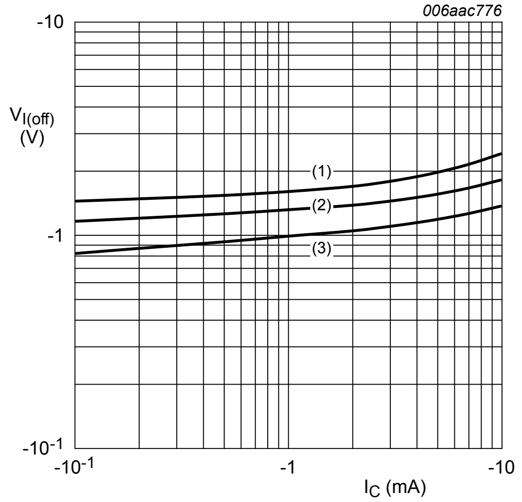
$I_C/I_B = 20$
(1) $T_{amb} = 100\ °C$
(2) $T_{amb} = 25\ °C$
(3) $T_{amb} = -40\ °C$

Fig. 5. Collector-emitter saturation voltage as a function of collector current; typical values



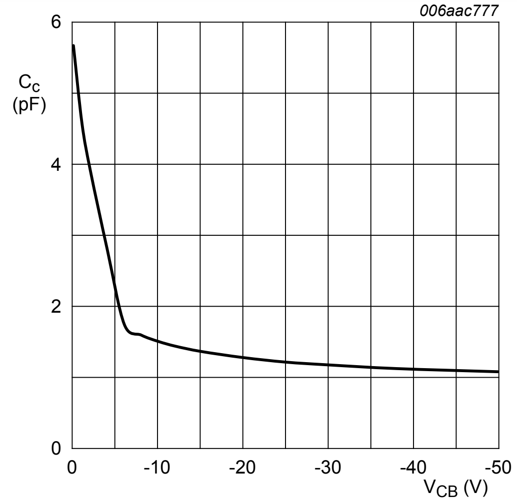
$V_{CE} = -0.3\ V$
(1) $T_{amb} = -40\ °C$
(2) $T_{amb} = 25\ °C$
(3) $T_{amb} = 100\ °C$

Fig. 6. On-state input voltage as a function of collector current; typical values



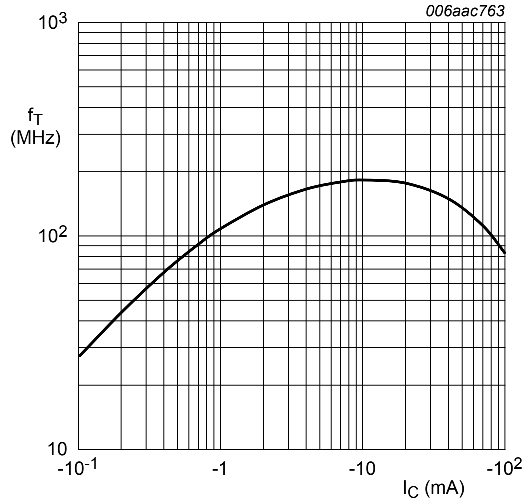
$V_{CE} = -5\ V$
(1) $T_{amb} = -40\ °C$
(2) $T_{amb} = 25\ °C$
(3) $T_{amb} = 100\ °C$

Fig. 7. Off-state input voltage as a function of collector current; typical values



f = 1 MHz; $T_{amb} = 25\ °C$

Fig. 8. Collector capacitance as a function of collector-base voltage; typical values



V_{CE} = -5 V; f = 100 MHz; T_{amb} = 25 °C

Fig. 9. Transition frequency as a function of collector current; typical values of built-in transistor

11. Test information

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

Resistor calculation

- Calculation of bias resistor 1 (R1)

$$R1 = \frac{V(I_{I2}) - V(I_{I1})}{I_{I2} - I_{I1}}$$

- Calculation of bias resistor ratio (R2/R1)

$$\frac{R2}{R1} = \frac{V(I_{I4}) - V(I_{I3})}{R1 \cdot (I_{I4} - I_{I3})} - 1$$

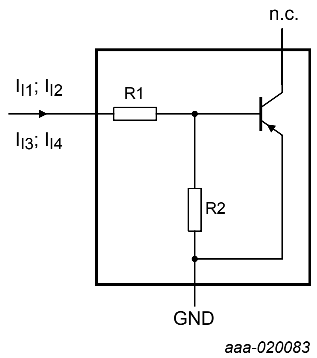


Fig. 10. Per transistor: Resistor test circuit

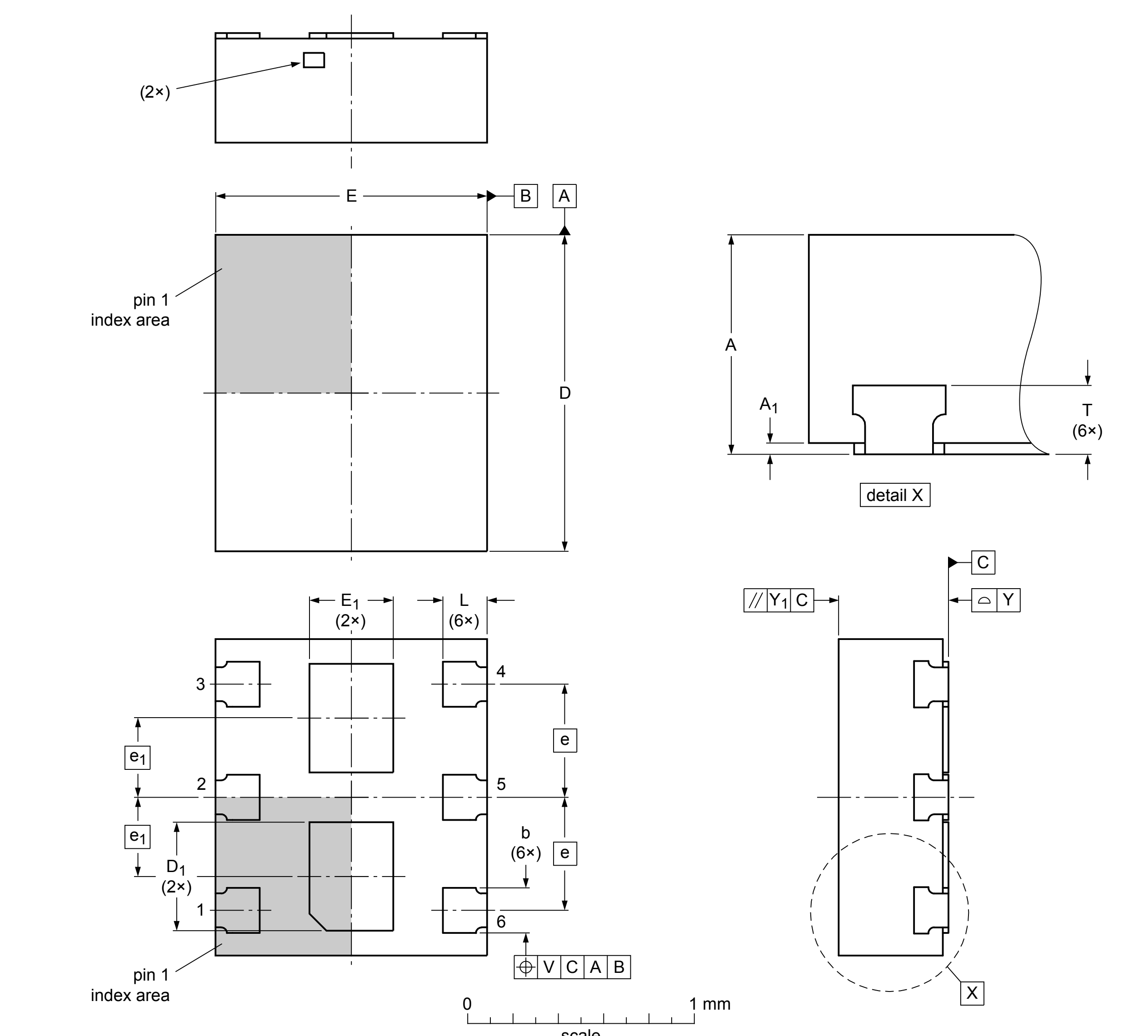
Resistor test conditions

Table 8. Resistor test conditions

R1 (kΩ)	R2 (kΩ)	Test conditions			
		I_{I1}	I_{I2}	I_{I3}	I_{I4}
10	10	-350 μA	-450 μA	350 μA	450 μA

12. Package outline

DFN1412-6: plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals; body: 1.4 x 1.2 x 0.47 mm **SOT1268**



Dimensions (mm are the original dimensions)

Unit(1)		A	A1	b	D	D1	E	E1	e	e1	L	T	V	Y	Y1
mm	min	0.44	0.00	0.15	1.35	0.43	1.15	0.32			0.145	0.10			
	nom	0.47		0.20	1.40	0.48	1.20	0.37	0.5	0.35	0.195	0.16	0.1	0.05	0.05
	max	0.50	0.04	0.25	1.45	0.53	1.25	0.42			0.245	0.22			

Note
1. Dimension A is including plating thickness.

sot1268_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1268		- - -				~~18-08-23~~ 18-09-11

Fig. 11. Package outline DFN1412-6 (SOT1268)

13. Soldering

Footprint information for reflow soldering of DFN1412-6 package **SOT1268**

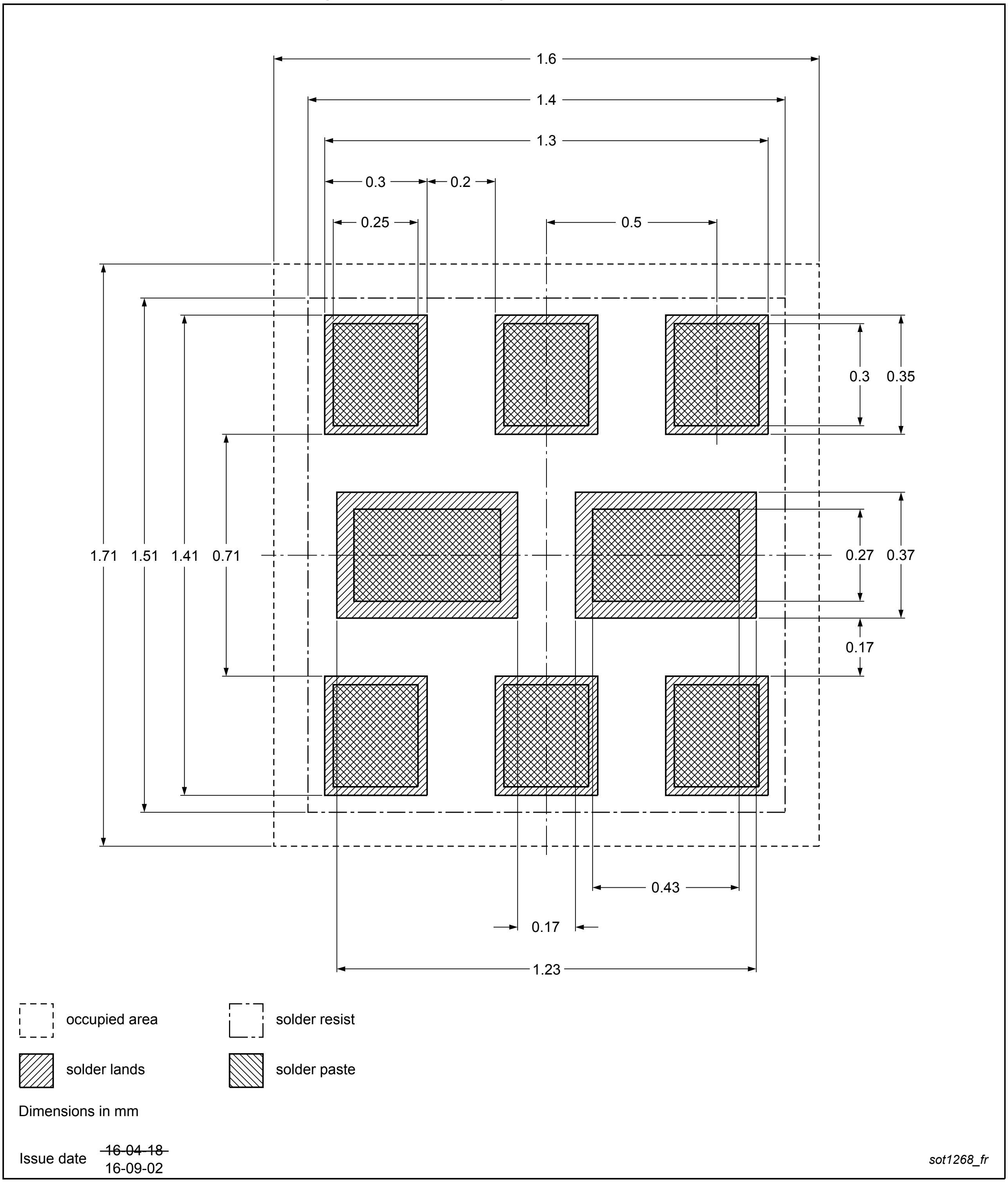


Fig. 12. Reflow soldering footprint for DFN1412-6 (SOT1268)

14. Revision history

Table 9. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PRMB11 v.2	20180914	Product data sheet	-	PRMB11 v.1
Modifications:	• Package outline drawing updated: Unit T added			
PRMB11 v.1	20170814	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

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